DNA/DNR-A0-308-352

16-bit, 8-Channel, ±13.5 V, Medium-Voltage Analog Output Board

- DNA-AO-308-352 for use in "Cube" I/O chassis
- DNR-AO-308-352 for use in RACKTangle® I/O chassis
- 8 independent DACs, 16-bit resolution
- 100kHz per channel max update rate
- ±13.5 V output range, ±13.5 mA per channel
- Per-channel offset and gain calibration
- Simultaneous update across all channels







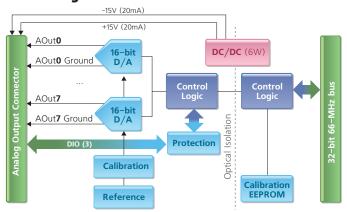


General Description:

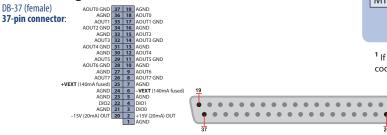
The DNA-AO-308-352 and DNR-AO-308-352 are high-precision, medium-voltage analog output boards compatible with UEI's "Cube" and RACKtangle I/O chassis respectively. The boards offer 16-bit, 8-channel high-voltage analog outputs with per-channel digital offset and gain calibration, buffered output, excellent linearity, and low output noise. The DNA/DNR-AO-308-352 is designed for the demanding high-voltage applications with ±13.5 V analog output span and up to ±13.5 mA of current per channel. This board is ideal for data acquisition and control applications requiring an output span up to 13.5 V. Since the maximum power consumption may exceeds 4.5W, this DNA-AO-308-352 may require the rear-mount fan (DNA-FANx) option in "Cube" applications.

Software is included, providing a comprehensive, yet easy-to-use API that supports all popular operating systems, including Windows, Linux, and most real-time operating systems—such as QNX, Intime, VXworks, and more. Additionally, the UEIDAQ Framework—an even higher level Windows driver—supplies complete support for those creating applications in many popular Windows programming languages, as well as data acquisition software packages such as LabVIEW and MATLAB/Simulink.

Block Diagram:



Pinout Diagram:



Technical Specifications:

Number of Channels	8
Resolution	16 bits
Max Update Rate:	
@ 16-bit resolution	100 kHz/chan (500 kHz max aggregate)
Buffer Size	1 K samples
Type of D/A	double-buffered
INL (no load)	±1 LSB (0.003%)
DNL (no load)	±1 LSB (0.003%)
Monotonicity Over Temperature	16 bits
Gain Linearity Error	0.002%
Gain Calibration Error	±1 mV
Offset Calibration Error	±1 mV
Offset Drift	5 ppm/°C
Gain Drift	5 ppm/°C
Output Range	±13.5 V
Output Coupling	DC
Output Impedance	0.1Ω max
Current Drive	±13.5 mA/channel
Capacitive Loads	500 pF
Settling Time	10 μs to 16 bits
Slew Rate	10 V/μs
Isolation	350 Vrms
Power Consumption ¹	2.2 W - 5 W
Physical Dimensions	3.875" x 3.875" (98 x 98 mm)
Operating Temp. (tested)	-40 °C to +85 °C
Operating Humidity	0 to 95%, non-condensing
Vibration IEC 60068-2-6 IEC 60068-2-64	5 g, 10-500 Hz, sinusoidal 5 g (rms), 10-500Hz, broadband random
Shock IEC 60068-2-27	100 g, 3 ms half sine, 18 shocks @ 6 orientations 30 g, 11 ms half sine, 18 shocks @ 6 orientations
Altitude	120,000 ft
MTBF	480,000 hours

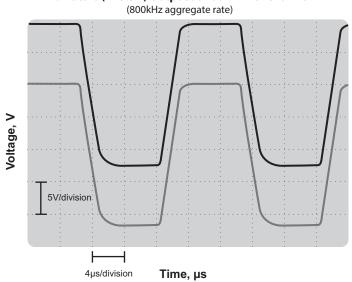
¹ If the total power consumption of the layer is over the 4.5W, the DNA-FANx rear-mount cooling fan is required. Refer to the Typical Performance Characteristics for more details.

Connection Options:

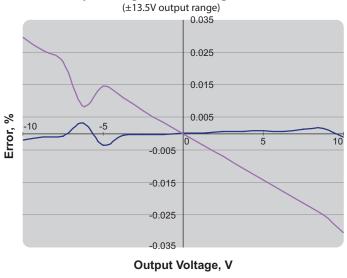
•			
	Terminal Panel	Cable	Description
	DNA-STP-37 DNA-CBL-37S		DNA-CBL-37S shielded cable connects the DNA/DNR-AO-308 to the 37-way DNA-STP-37 screw terminal panel
	DNA-STP-37	DNA-CBL-37	DNA-CBL-37 ribbon cable connects the DNA/DNR-AO-308 to the 37-way DNA-STP-37 screw terminal panel

Typical Performance Characteristics

Full Scale (±13.5V) Output at 100kHz Per Channel

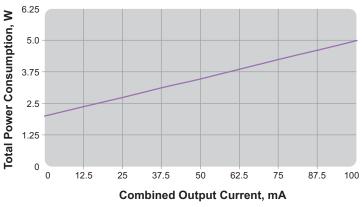


Output Voltage Error vs. Voltage vs. Load



_____ 2 KOhm load _____ 1 MOhm load

Power Consumption vs. Output Current

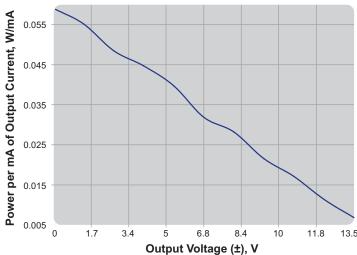


Conversion Factors

Resolution			
bits	%	mV	
14	0.006104	4.883	
15	0.003052	2.441	
16	0.001526	1.221	

Internal Power Dissipation vs. Output Voltage

±13.5 V (20 mA max)



Note: Total internal power consumption = 1.5W + (Total output current x Power/mA at given voltage)